

LNA4801L

GaAlAs Infrared Light Emitting Diode

For optical control systems

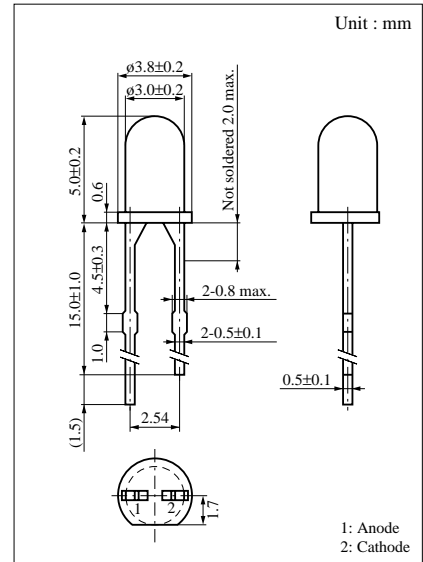
■ Features

- Fast response and high-speed modulation capability :
 $f_c = 20 \text{ MHz (typ.)}$
- Wide directivity : $\theta = 22 \text{ deg. (typ.)}$
- Transparent epoxy resin package

■ Absolute Maximum Ratings (Ta = 25°C)

Parameter	Symbol	Rated	Unit
Power dissipation	P_D	190	mW
Forward current (DC)	I_F	100	mA
Pulse forward current	I_{FP}^*	1	A
Reverse voltage (DC)	V_R	3	V
Operating ambient temperature	T_{opr}	-25 to +85	°C
Storage temperature	T_{stg}	-30 to +100	°C

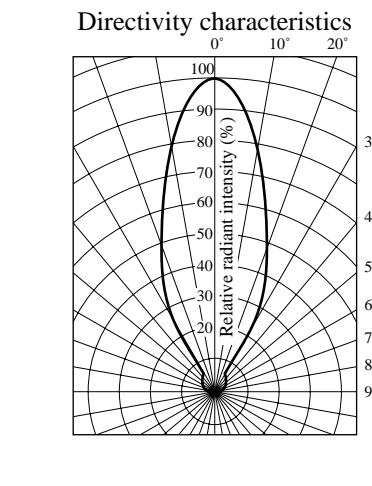
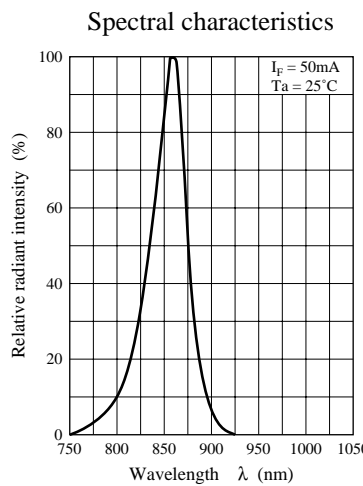
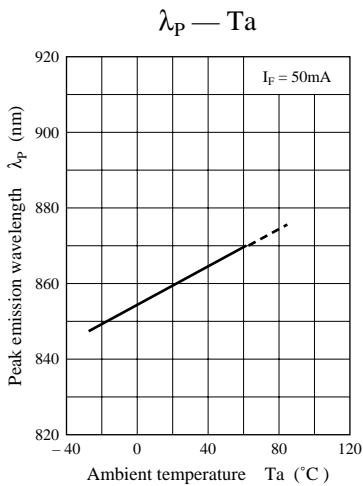
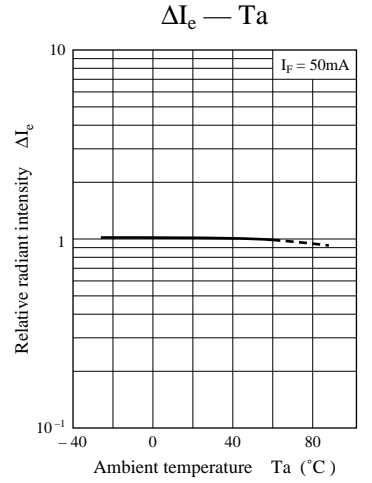
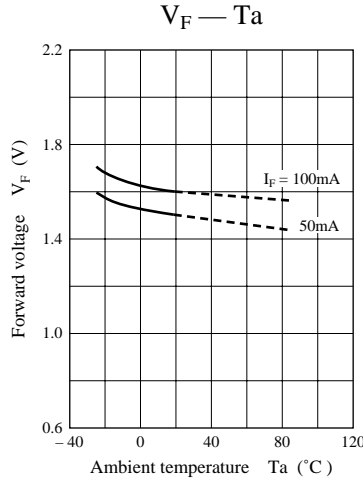
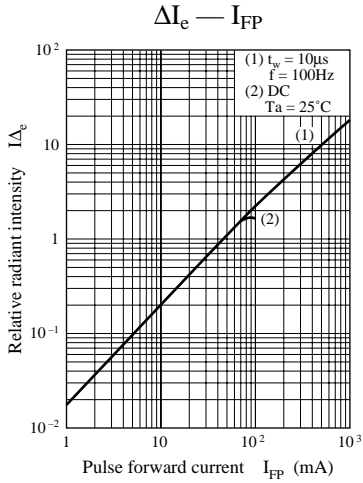
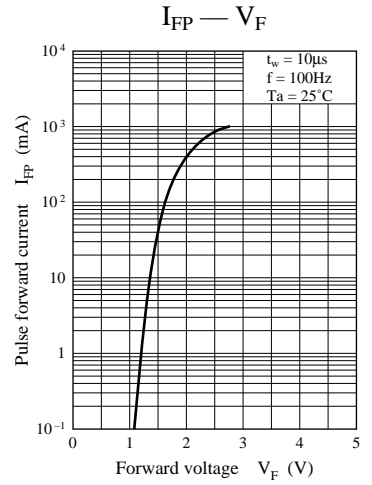
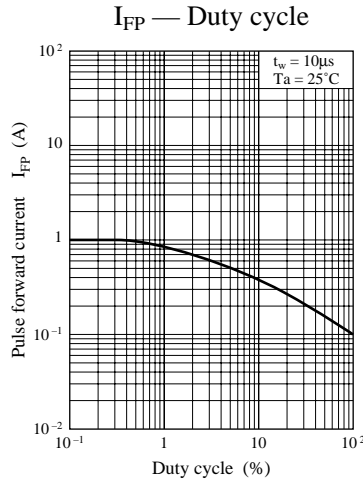
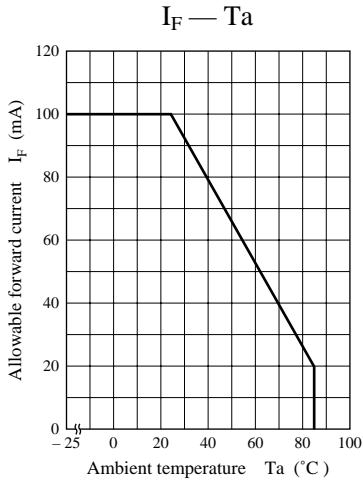
* f = 100Hz, Duty cycle = 0.1 %



■ Electro-Optical Characteristics (Ta = 25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Center radiant intensity	I_e	$I_F = 50\text{mA}$	12			mW/sr
Peak emission wavelength	λ_p	$I_F = 50\text{mA}$		860		nm
Spectral half band width	$\Delta\lambda$	$I_F = 50\text{mA}$		40		nm
Forward voltage (DC)	V_F	$I_F = 100\text{mA}$		1.6	1.9	V
Reverse current (DC)	I_R	$V_R = 3\text{V}$			10	μA
Half-power angle	θ	The angle in which radiant intensity is 50%		22		deg.
Cutoff frequency	f_c^*	$I_{FP} = 50\text{mA} + 10\text{mA}_{p-p}$		20		MHz

* Frequency when modulation optical power decreases by 3dB from 1MHz $\left(10 \log \frac{P_O(f_c\text{MHz})}{P_O(1\text{MHz})} = -3 \right)$



Caution for Safety

 **DANGER**

Gallium arsenide material (GaAs) is used in this product.

Therefore, do not burn, destroy, cut, crush, or chemically decompose the product, since gallium arsenide material in powder or vapor form is harmful to human health.

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